Docket No.

245965US2 '

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

Takashi MIYAJIMA

SERIAL NO: New Application

GAU:

FILED:

Herewith

EXAMINER:

FOR:

METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- ☐ Attached is a list of applicant's pending application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the pending application(s) is attached along with PTO 1449.
- A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.

Marvin J. Spivak

Registration No. 24,913

C. Irvin McClelland Registration Number 21,124

Customer Number

Tel. (703) 413-3000 Fax. (703) 413-2220 (OSMMN 05/03)

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Form PTO 1449	U.S. DEPARTMENT OF COMMERCE			ATTY DOCKET NO.		SERIAL NO.	
(Modified)		PATENT AND TRAD	EMARK OFFICE	245965US2		New Application	
				APPLICANT			
LIST OF REFERENCES CITED BY APPLICANT				Takashi MIYAJIMA			
				FILING DATE		GROUP	
				Herewith			
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	. NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	US 2001/0008783 AI	7/19/01	Jae Kap KIM			
	AB	6,165,864	12/26/00	Hua SHEN, et al.			
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FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY		TRANSLATION YES NO	
	AO	2002-198498	7/12/02	Japan (with English Extract)	pan (with English Extract)		Х
	AP	2002-124649	4/26/02	Japan (with English Extract)	an (with English Extract)		X
	AQ	8-70106	3/12/96	Japan (with English Extract)	lish Extract)		X
	AR	2001-210805	8/3/01	Japan (Correpsonding U.S. Patent 2001/0008			X
	AS	2000-58795	2/25/00	Japan (Corresponding U.S. Patent 6,1	65,864)		×
	AT					<u> </u>	
	AU						
	AV						
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)							
	AW						
	AX						
	AY						
	AZ				Add	itional Refe	erences sheet(s) attached
Examiner				A discontinued in	Date Considered		
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							